



Features:





- Comply with IEEE 802.3 50GAUI-1 C2M electrical interface.
- Management Interface comply with SFF-8472
- Comply with SFF-8432 with duplex LC connector
- Up to 10km transmission on SMF
- 2-wire interface with integrated Digital Diagnostic monitoring
- DFB laser and PIN receiver
- Support 10Gbps/25Gbps/26.5625GBd rate selection
- Single +3.3V power supply
- Power consumption lower than 2W
- Operating case temperature: Industry temp: -40~+85°C
 Commercial temp: 0~70°C



Notes: picture in this page is just for demo

Regulatory Compliance

Table 1 - Regulatory Compliance

Feature	Standard	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1(>1000V for SFI pins, >2000V for other pins.)
Electrostatic Discharge (ESD) to the Duplex LC Receptacle	IEC 61000-4-2 GR-1089-CORE	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN55022 Class B (CISPR 22B)	Compatible with standards
Immunity	IEC 61000-4-3	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN60950, EN (IEC) 60825-1,2	Compatible with Class I laser product.
RoHS	EU 2015/863	Compliant with exemption 7C(I)



Absolute Maximum Ratings

Table 2 - Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	TS	-40	-	+85	°C	
Operating Relative Humidity	RH	10	-	+85	%	

Recommended Operating Conditions

Table 3 – Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case Temperature	T _{OPR}	-40	ı	85	ပ္	I-temp
	OPR	0		70	ပ္	C-temp
Power Supply Voltage	Vcc	3.135	3.3	3.465	V	
Power Dissipation	Р	-	-	2	W	
Data Rate	DR		26.5625	-	GBd	
Transmission Distance	TD	-	=	10	km	1

Note:

1. Measured with SMF.

Optical and Electrical Characteristics

Table 4 - Transmitter Optical Specifications

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Center Wayslangth Dange	1 -	1304.5		1317.5	nm	1
Center Wavelength Range	λο	1300		1320	nm	2
Modulation Fomart			PAM4			
Average Output Power	P _{0UT}	-4.5	-	4.2	dBm	
Outer Optical Modulation Amplitude	OMA	-1.5	-	4	dBm	
TDECQ	TDECQ			3.2	dB	
Average Output Power (Laser Off)	P _{0UT-OFF}	-	-	-30	dBm	
Extinction Ratio	ER	3.5	-	-	dB	
RIN15.6OMA				-132	dB/H	
KIN 15.60IVIA	-		-	-132	Z	
Optical return loss tolerance	-	-	-	15.6	dB	
Transmitter reflectance	-	-	-	-26	dB	

Notes:

1. For C temp 0~70°C



2. For I temp -40~85°C

Table 5 - Receiver Optical Specifications

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Center Wavelength Range	λc	1295	1311	1325	nm	
Damage threshold	-	-	-	5.2	dBm	1
Average receive power		-10.8		4.2	dBm	
Receiver Power (OMAouter)	-	-	-	4	dBm	2
Receiver sensitivity (OMAouter)		Max(-	-8.4, SECC	Q – 9.8)	dBm	2
LOS Assert	LOSA	-30	-		dBm	
LOS De-assert	LOS₀	-	-	-11	dBm	
LOS Hysteresis	LOSH	0.5	-	-	dB	

Notes

- 1. The receiver shall be able to tolerate, without damage, continuous exposure to an optical signal having this average power level. The receiver does not have to operate correctly at this input power
- 2. Measured with a PRBS31Q test pattern @26.5625 GBd, BER≤2.4X10^-4.

Table 6 - Electrical Specifications

Transmitter (Module Input)								
Pa	Symbol	Min.	Typical	Max.	Unit	Notes		
Differential Data	Input Amplitude	V _{IN,P-P}	180	-	900	mVpp		
Input Differentia	l Impedance	Z _{IN}	90	100	110	Ω		
Ty Foult	Normal Operation	Vol	-0.3	-	0.4	V		
Tx_Fault	Transmitter Fault	Vон	2.4	-	Vcc	V		
Tx Disable	Normal Operation	VIL	-0.3	-	0.8	V		
TX_DISAble	Laser Disable	VIH	2.0	-	Vcc+0.3	V		
	F	Receiver (N	lodule Ou	tput)				
Differential Data	Output Amplitude	V _{OUT,P-P}	300	-	1000	mVpp		
Output Differential Impedance		Zo	90	100	110	Ω		
D. 100	Normal Operation	Vol	-0.3	-	0.4	V		
Rx_LOS	Lose Signal	Vон	2.4	-	Vcc	V		

Recommended Host Board Power Supply Circuit

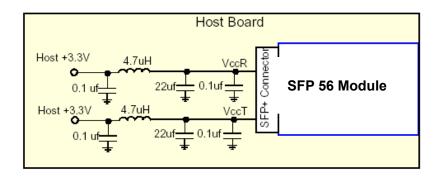


Figure 1, Recommended Host Board Power Supply Circuit

Recommended Interface Circuit

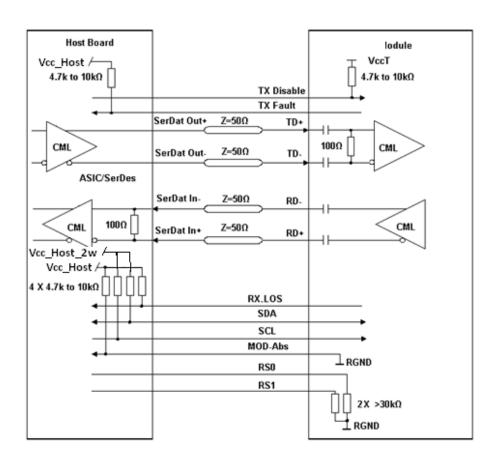


Figure 2, Recommended Interface Circuit

Preliminary Datasheet SP-50E-LR-C(I)DFA 50G LR(10km) SFP56 PAM4

Pin Definitions

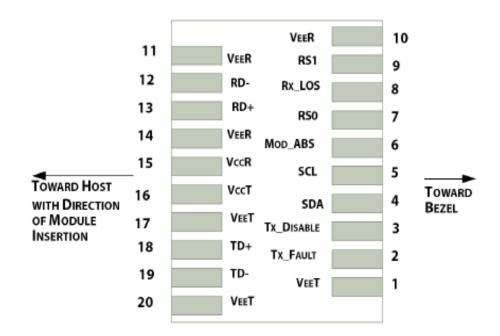


Figure 3, Pin View

Table 7 - Pin Definitions

Contacts	Logic	Symbol	Description	Notes
case		case	Module case	2
1		VEET	Module Transmitter Ground	3
2	LVTTL-O	TX_F _{AULT}	Module Transmitter Fault	4
3	LVTTL-I	TX_DISABL E	Transmitter Disable; Turns off transmitter laser output	5
4	LVTTL-I/O	SDA	2-wire Serial Interface Data Line(Same as MOD- DEF2 in INF-8074i)	6
5	LVTTL-I/O	SCL	2-wire Serial Interface Clock (Same as MOD- DEF1 in INF-8074i)	6
6		MOD_ABS	Module Absent, connected to VEET or VEER in the module	7
7	LVTTL-I	RS0	Rx Rate Select	
8	LVTTL-O	RX_LOS	Receiver Loss of Signal Indication(In FC designated as Rx_LOS and in Ethernet designated as Signal Detect)	4
9	LVTTL-I	RS1	Tx Rate Select	
10		VEER	Module Receiver Ground	3



Preliminary Datasheet SP-50E-LR-C(I)DFA 50G LR(10km) SFP56 PAM4

11		VEER	Module Receiver Ground	3
12	CML-O	RD-	Receiver Inverted Data Output	
13	CML-O	RD+	Receiver Non-Inverted Data Output	
14		$V_{EE}R$	Module Receiver Ground	3
15		VccR	Module Receiver 3.3 V Supply	
16		VccT	Module Transmitter 3.3 V Supply	
17		$V_{EE}T$	Module Transmitter Ground	3
18	CML-I	TD+	Transmitter Non-Inverted Data Input	
19	CML-I	TD-	Transmitter Inverted Data Input	
20		$V_{EE}T$	Module Transmitter Ground	3

Notes:

- 1. Labeling as inputs (I) and outputs (O) are from the perspective of the module.
- 2. The case makes electrical contact to the cage before any of the board edge contacts are made.
- 3. The module signal ground contacts, VeeR and VeeT, should be isolated from the module case.
- 4. This contact is an open collector/drain output contact and shall be pulled up on the host. Pull ups can be connected to one of several power supplies, however the host board design shall ensure that no module contact has voltage exceeding module VccT/R + 0.5 V.
- 5. Tx_Disable is an input contact with a 4.7 kOhms to 10 kOhms pullup to VccT inside the module.
- 6. 2-wire interface.
- 7. The pins shall be pulled up with 4.7K-10Kohms to a voltage between 3.14V and 3.46V on host board.

Rate select logic

Table 8 - Rate selection

A2.73.bit 4 is default to 0b, which allows both RS0(1) pins and RS0(1) bits control.

50G PMA4 Enable (A2.119.Bit2)	RS0 (pin #7)	Soft RSO select (A2.110.bit3)	RS1 (pin #9)	Soft RS1 select (A2.118.bit3)	Rate (both Tx&Rx)
0	0	0	х	х	work on 10Gbps
0	0	1	х	х	work on 25Gbps
0	1	0	х	х	work on 25Gbps
0	1	1	х	х	work on 25Gbps
1	х	Х	х	х	work on 50Gbps

Mechanics Drawing

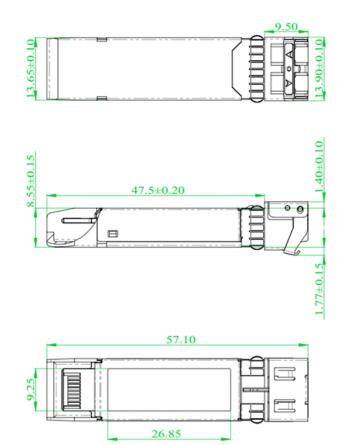


Figure 4 Mechanics drawing

Order Information

Table 9 - Order Information

Part No.	Application	Data Rate	Laser Source	Fiber Type
SP-50E-LR-CDFA	eCPRI/50GBASE-LR 0~70°C	26.5625 GBd	DFB	SMF
SP-50E-LR-IDFA	eCPRI/50GBASE-LR -40~85°C	20.3023 GBU	DFB	SIVIF



Preliminary Datasheet SP-50E-LR-C(I)DFA 50G LR(10km) SFP56 PAM4

Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation

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